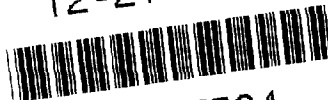


JULY 28, 1992

U.S. PA

0450 TMOG 77

12-21-2000



101557594

NOTE: The following appendix did not appear in the Code of Federal Regulations

APPENDIX B

FORM PTO-1595

1-31-92

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PATENTS ONLY**

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To the Honorable Commissioner of Patents and Trademarks. Please record the attached original documents or copy thereof.

1. Name of conveying party(ies):

Robert Edward Fontana, Jr.
Richard Hsiao

2. Name and address of receiving party(ies):

Name: *INTERNATIONAL BUSINESS
MACHINES CORPORATION*
Internal Address: Armonk, New York 10504
Street Address: SAME AS ABOVE

Additional name(s) & address(es) attached?
yes ☒ no

Additional name(s) of conveying party(ies) attached? yes ☒ no

3. Nature of Conveyance

☒ Assignment ☐ Merger
☐ Security Agreement ☐ Change of Name
☐ Other

Execution Date: 11/21/2000; 11/22/2000

4. Application number(s) or patent number(s):

If this document is being filed together with a new application, the execution date of the application is: 11/21/2000; 11/22/2000

A. Patent Application No.(s)

B. Patent No.(s)

Additional numbers attached? Yes ☒ No

5. Name and address of party to whom correspondence concerning documents should be mailed:

Name: Paik Saber
Address: INTERNATIONAL BUSINESS MACHINES CORPORATION
5600 Cottle Road, L2PA/014
San Jose, California 95193

6. Total number of applications and patents involved: 1

7. Total Fee (37 CFR 3.41): \$ 40.00
☐ Enclosed
☒ Authorized to be charged to deposit account

8. Deposit Account Number: 09-0442

12/20/2000 NTH011 00000507 090442 09724247

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To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.

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Nov. 27, 2000

Date

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**PATENT
REEL: 011343 FRAME: 0226**

ASSIGNMENT

Whereas, we

INVENTOR
AND CITY

- (1) **Robert Edward Fontana, Jr.**
City of **San Jose**,
County of **Santa Clara**
State of **California**
- (2) **Richard Hsiao**
City of **San Jose**,
County of **Santa Clara**
State of **California**

have invented certain improvements in

TITLE

**METHOD OF MAKING AN ELECTRONIC LAPPING GUIDE (ELG) FOR LAPPING
A READ SENSOR**

DATE THAT
INVENTOR
SIGNED THE
DECLARATION

and executed a Declaration and Power of Attorney for a United States patent application therefor on

- (1) 11/21, 2000 (2) 11/22, 2000

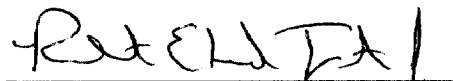
Whereas, INTERNATIONAL BUSINESS MACHINES CORPORATION, a corporation of New York, having a place of business at Armonk, New York 10504, (hereinafter called IBM), desires to acquire the entire right, title and interest in the said application and invention, and to any United States and foreign patents to be obtained therefor;

Now therefore, for a valuable consideration, receipt whereof is hereby acknowledged, I, the above named, hereby sell, assign, and transfer to IBM, its successors and assigns, the entire right, title and interest in the said application and invention therein disclosed for the United States and foreign countries, and all rights of priority resulting from the filing of said United States application, and I request the Commissioner of Patents to issue any Letters Patent granted upon the inventions set forth in said application to IBM, its successors and assigns; and I hereby agree that IBM may apply for foreign Letters Patent on said invention and I will execute all papers necessary in connection with the United States and foreign applications when called upon to do so by IBM.

Signed

CITY
DATE

- (1) at SAN JOSE, CA
on 11/21, 2000,

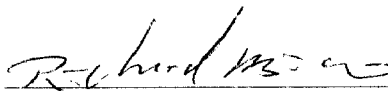


Robert Edward Fontana, Jr.

SIGNATURE
INVENTOR

CITY
DATE

- (2) at SAN JOSE, CA
on 11/22, 2000,



Richard Hsiao

SIGNATURE
INVENTOR